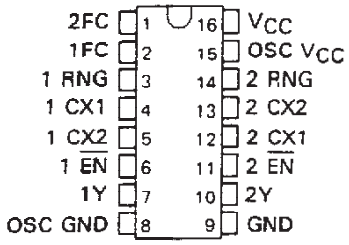
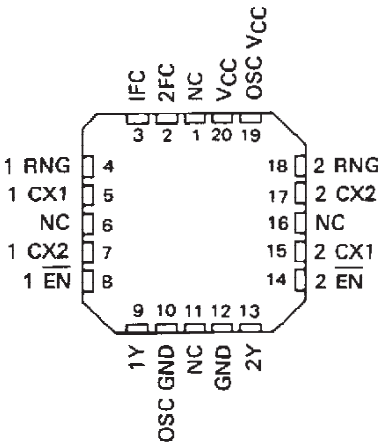
SDLS201A – DECEMBER 1983 – REVISED APRIL 2004

- Two independent VCOs in a 16-Pin Package
- Output Frequency Set by Single External Component:
  - Capacitor for Fixed- or Variable-Frequency Operation
- Separate Supply Voltage Pins for Isolation of Frequency Control Inputs and Oscillators from Output Circuitry
- Highly Stable Operation over Specified Temperature and/or Supply Voltage Ranges
- Typical f_{max} . . . . . 85 MHz
  Typical Power Dissipation . . . . . 525 mW
- Frequency Spectrum . . . 1 Hz to 60 MHz

SN54S124 . . . J OR W PACKAGE
SN74S124 . . . D OR N PACKAGE
(TOP VIEW)



SN54S124 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

description

The 'S124 features two independent voltage-controlled oscilllators (VCO) in a single monolithic chip. The output frequency of each VCO is established by an external capacitor in combination with two voltage-sensitive inputs, one for frequency range and one for frequency control. These inputs can be used to vary the output frequency as shown under typical characteristcs. These highly stable oscillators can be set to operate at any frequency typically between 0.12 hertz and 85 megahertz.

While the enable input is low, the output is enabled. While the enable input is high, the output is high.

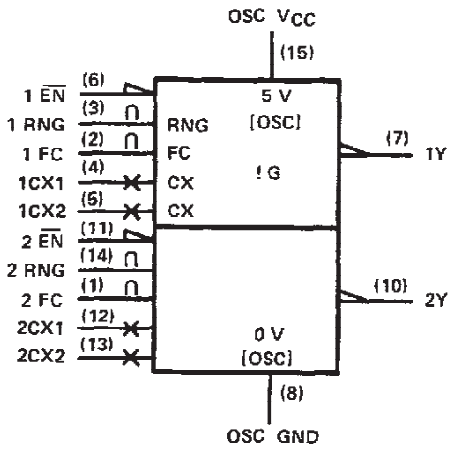
These devices can operate from a single 5-volt supply. However, one set of supply-voltage and ground pins (V_{CC} and GND) is provided for the enable, synchronization-gating, and output sections, and a separate set ($\ominus V_{CC}$ and $\ominus$GND) is provided for the oscillator and associated frequency-control circuits so that effective isolation can be accomplished in the system.

The enable input of these devices starts or stops the output pulses when it is low or high, respectively. The internal oscillator of the 'S124 is started and stopped by the enable input. The enable input is one standard load; it and the buffered output operate at standard Schottky-clamped TTL levels.

The pulse synchronization-gating section ensures that the first output pulse is neither clipped nor extended. Duty cycle of the square-wave output is fixed at approximately 50 percent.

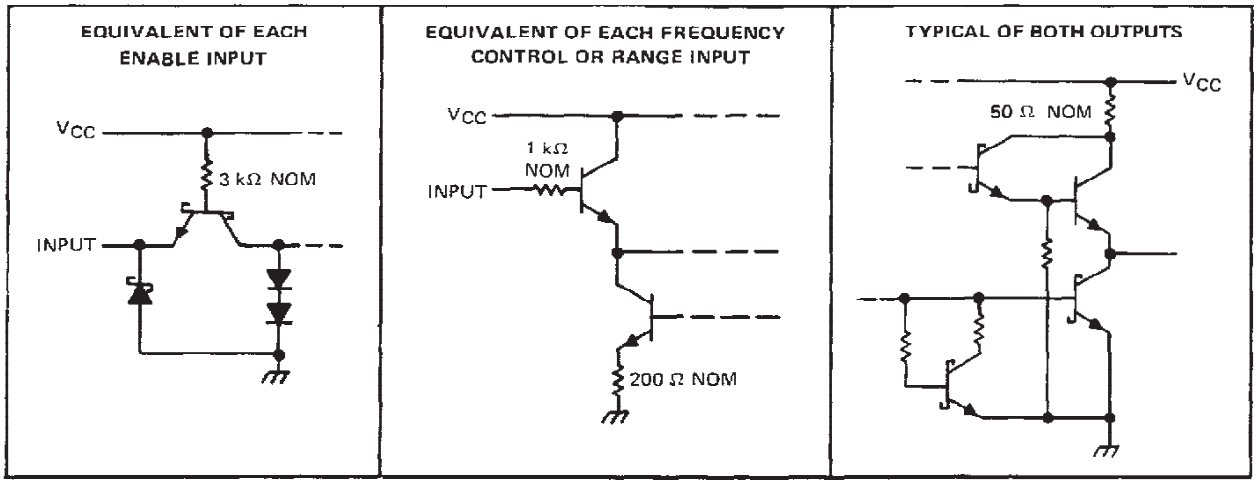
The SN54S124 is characterized for operation over the full military temperature range of −55°C to 125°C; the SN74S124 is characterized for operation from 0°C to 70°C.

logic symbol†



†This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for D, J, N, and W packages.

schematics of inputs and outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (See Notes 1 and 2) 7V
Input voltage . . . . . 5.5 V
Operating free-air temperature range: SN54S124 . . . . . −55°C to 125°C
SN74S124 . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTES: 1. Voltage values are with respect to the appropriate ground terminal.
2. Throughout this data sheet, the symbol V_{CC} is used for the voltage applied to both the V_{CC} and $\ominus V_{CC}$ terminals, unless otherwise noted.

recommended operating conditions

	SN54S124			SN74S124			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC} (see Note 1)	4.5	5	5.5	4.75	5	5.25	V
Input voltage at frequency control or range input, $V_{I(freq)}$ or $V_{I(rng)}$	1		5	1		5	V
High-level output current, I_{OH}			−1			−1	mA
Low-level output current, I_{OL}			20			20	mA
Output frequency (enabled), f_o	1			1			Hz
			60			60	MHz
Operating free-air temperature, T_A	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†		MIN	TYP‡	MAX	UNIT
V_{IH}	High-level input voltage at enable				2			V
V_{IL}	Low-level input voltage at enable						0.8	V
V_{IK}	Input clamp voltage at enable		V_{CC} = MIN, I_I = −18 mA				−1.2	V
V_{OH}	High-level output voltage		V_{CC} = MIN, V_{IH} = 2 V, I_{OH} = −1 mA	SN54S'	2.5	3.4		V
				SN74S'	2.7	3.4		
V_{OL}	Low-level output voltage		V_{CC} = MIN, V_{IL} = 0.8 V, I_{OL} = 20 mA				0.5	V
I_I	Input current	Freq control or range	V_{CC} = MAX	V_I = 5 V		10	50	μA
				V_I = 1 V		1	15	
I_I	Input current at maximum input voltage	Enable	V_{CC} = MAX, V_I = 5.5 V				1	mA
I_{IH}	High-level input current	Enable	V_{CC} = MAX, V_I = 2.7 V				50	μA
I_{IL}	Low-level input current	Enable	V_{CC} = MAX, V_I = 0.5 V				−2	mA
I_{OS}	Short-circuit output current§		V_{CC} = MAX		−40		−100	mA
I_{CC}	Supply current, total into V_{CC} and ⊖ V_{CC}		V_{CC} = MAX, See Note 3			105	150	mA
			V_{CC} = MAX, T_A = 125°C, See Note 3	W package only			110	

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡All typical values are at V_{CC} = 5 V, T_A = 25°C.
§Not more than one output should be shorted at a time and duration of the short-circuit should not exceed one second.
NOTE 3: I_{CC} is measured with the outputs disabled and open.

switching characteristics, V_{CC} = 5 V, R_L = 280 Ω, C_L = 15 pF, T_A = 25°C (see note 4)

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
f_o	Output frequency	C_{ext} = 2 pF	$V_{I(freq)}$ = 4 V, $V_{I(rng)}$ = 1 V	60	85		MHz
			$V_{I(freq)}$ = 1 V, $V_{I(rng)}$ = 5 V	25	40		
	Output duty cycle	C_{ext} = 8.3 pF to 500 μF			50%		
t_{PHL}	Propagation delay time, high-to-low-level output from enable	f_o = 1 Hz to 20 MHz			$\frac{1.4}{f_{o(Hz)}}$		s
		f_o > 20 MHz			70		ns

NOTE 4: Load circuits and voltage waveforms are shown in Section 1.

TYPICAL CHARACTERISTICS

BASE OUTPUT FREQUENCY
vs
EXTERNAL CAPACITANCE

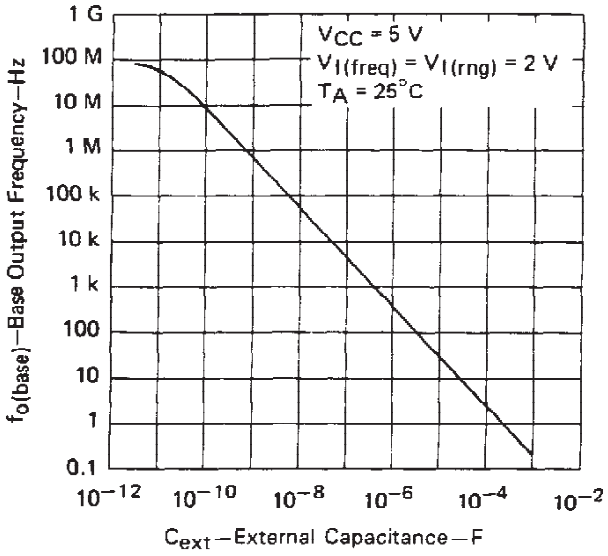


FIGURE 1

NORMALIZED OUTPUT FREQUENCY
vs
INPUT VOLTAGE

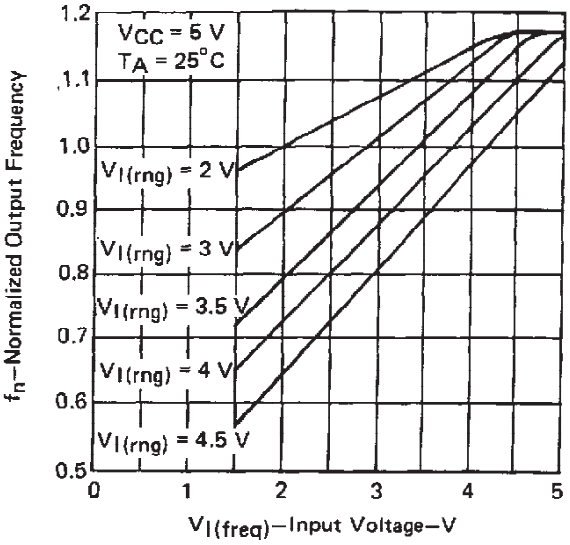


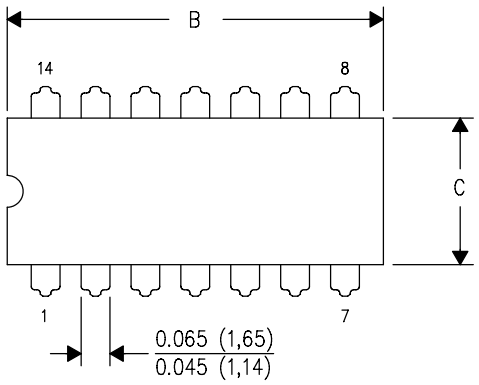
FIGURE 2

NOTE: $f_o = f_n \times f_{o(base)}$

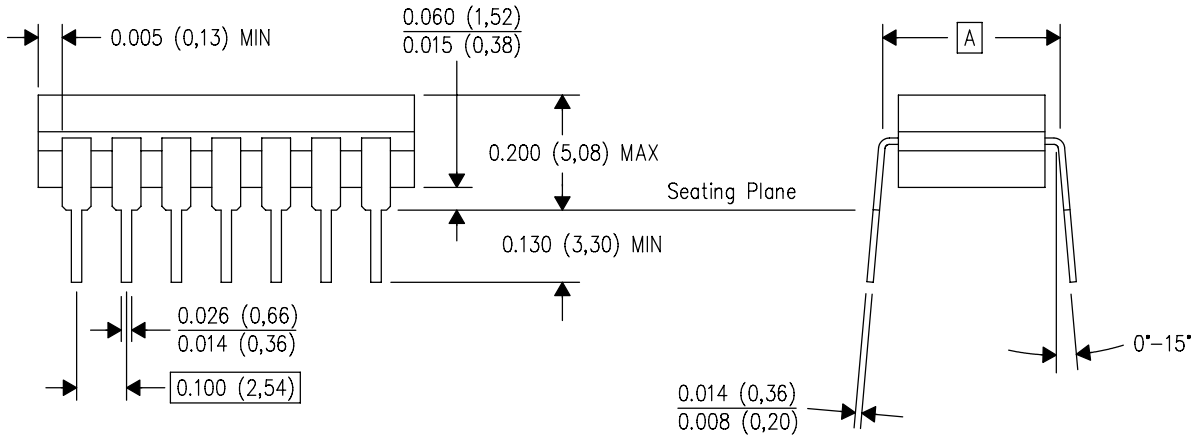
J (R–GDIP–T**)

14 LEADS SHOWN

CERAMIC DUAL IN–LINE PACKAGE



DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)

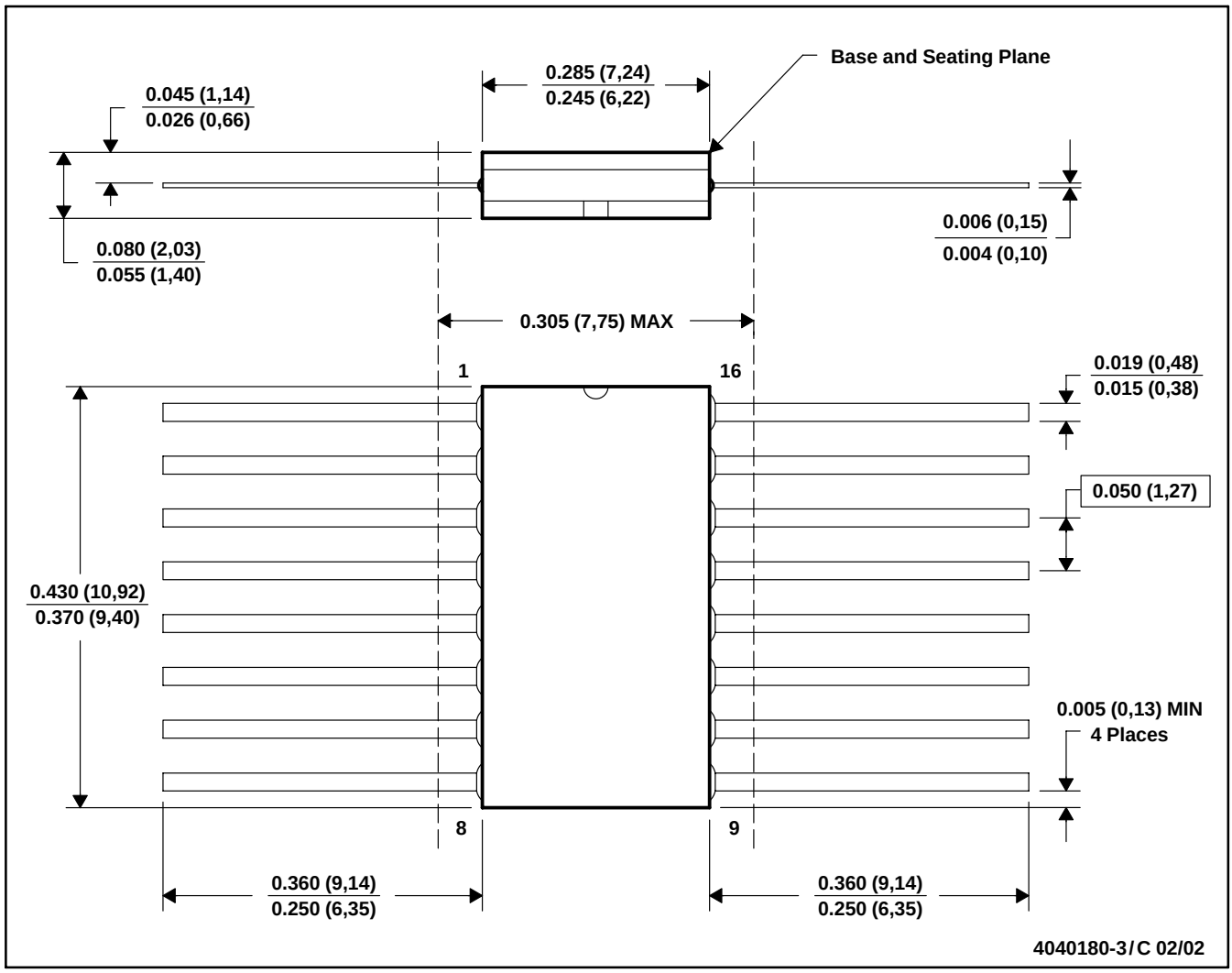


4040083/F 03/03

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package is hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
E. Falls within MIL STD 1835 GDIP1–T14, GDIP1–T16, GDIP1–T18 and GDIP1–T20.

MCFP004A– JANUARY 1995 – REVISED FEBRUARY 2002

W (R-GDFP-F16) **CERAMIC DUAL FLATPACK**

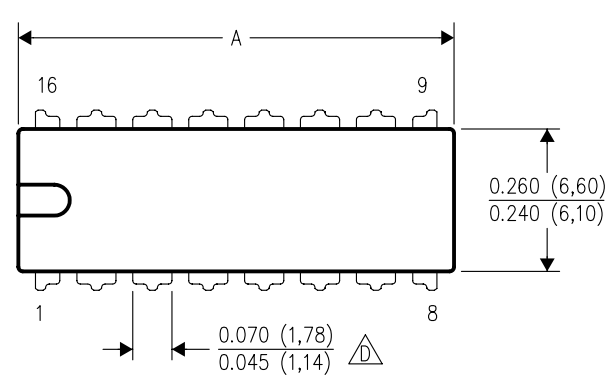


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only.
E. Falls within MIL STD 1835 GDFP-1F16 and JEDEC MO-092AC

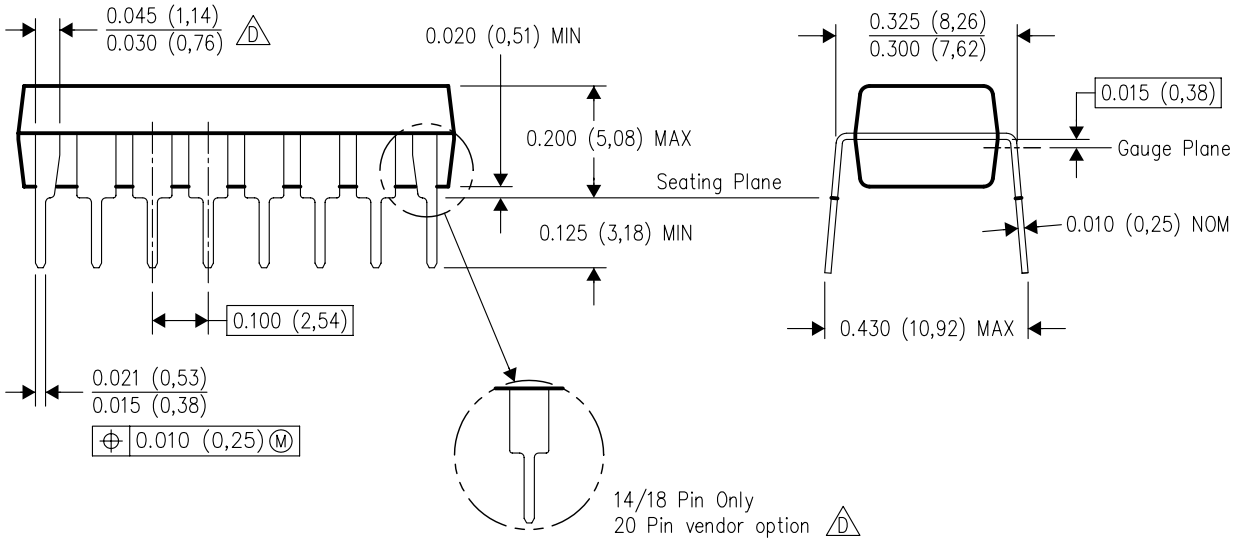
N (R–PDIP–T**)

PLASTIC DUAL–IN–LINE PACKAGE

16 PINS SHOWN



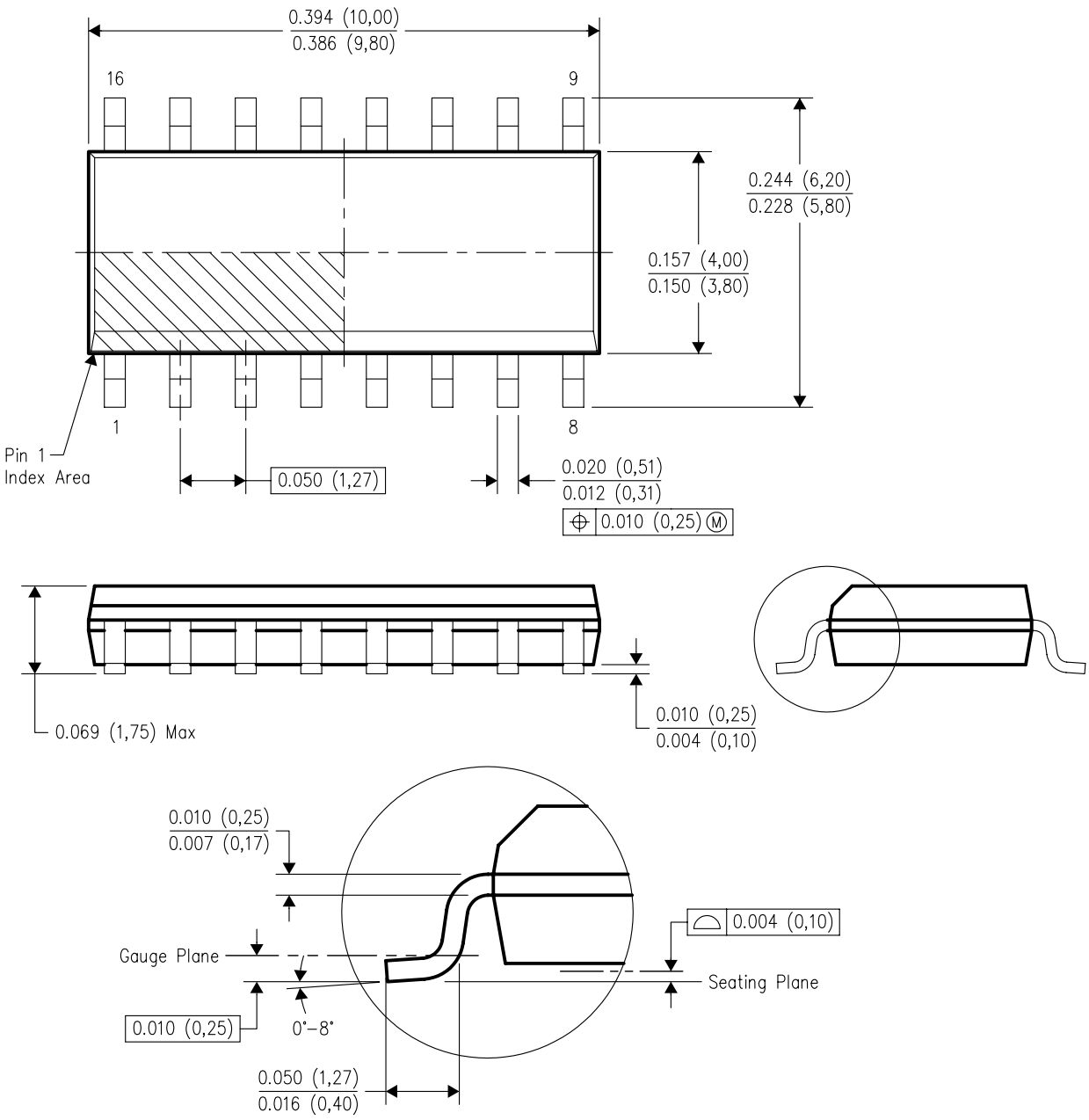
DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS–001 VARIATION (C)	AA	BB	AC	AD



4040049/E 12/2002

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS–001, except 18 and 20 pin minimum body length (Dim A).
D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R–PDSO–G16) PLASTIC SMALL–OUTLINE PACKAGE



NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
D. Falls within JEDEC MS–012 variation AC.

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